

TOSHIBA Field-Effect Transistor Silicon N-Channel MOS Type

SSM3K37MFV

High Speed Switching Applications

Analog Switch Applications

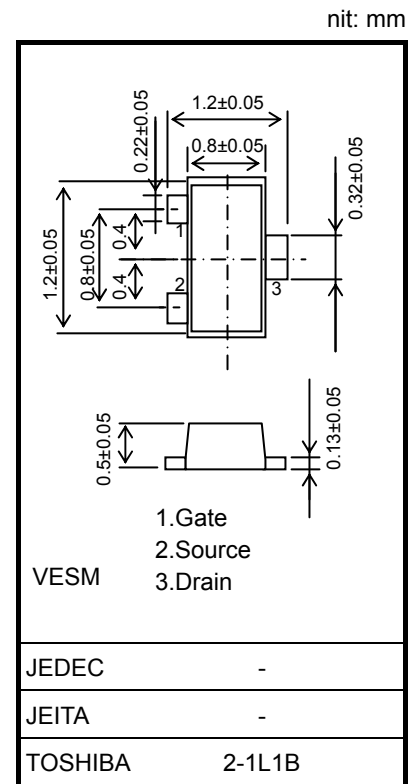
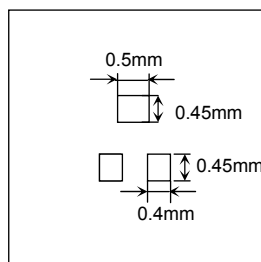
- 1.5-V drive
- Low ON-resistance
 - $R_{DS(ON)} = 5.60\Omega$ (max) (@ $V_{GS} = 1.5$ V)
 - $R_{DS(ON)} = 4.05\Omega$ (max) (@ $V_{GS} = 1.8$ V)
 - $R_{DS(ON)} = 3.02\Omega$ (max) (@ $V_{GS} = 2.5$ V)
 - $R_{DS(ON)} = 2.20\Omega$ (max) (@ $V_{GS} = 4.5$ V)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	20	V
Gate-source voltage		V_{GSS}	±10	V
Drain current	DC	I_D	250	mA
	Pulse	I_{DP}	500	
Drain power dissipation (Ta = 25°C)		P_D (Note 1)	150	mW
Channel temperature		T_{ch}	150	°C
Storage temperature		T_{stg}	-55 to 150	°C

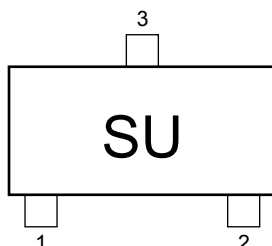
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on a FR4 board (25.4 mm × 25.4 mm × 1.6 mm)

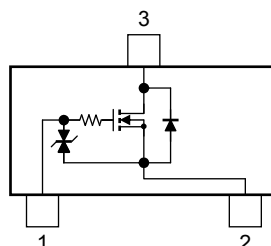


Weight: 1.5mg (typ.)

Marking



Equivalent Circuit



Start of commercial production
2010-02

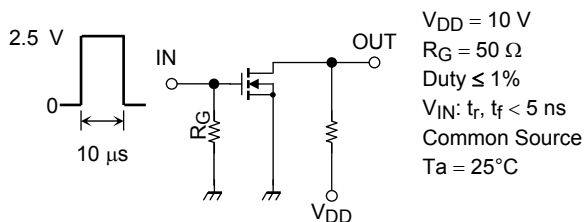
Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	20	—	—	V
	$V_{(BR)DSX}$	$I_D = 1 \text{ mA}, V_{GS} = -10 \text{ V}$	12	—	—	
Drain cutoff current	I_{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	—	—	1	μA
Gate leakage current	I_{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0 \text{ V}$	—	—	± 1	μA
Gate threshold voltage	V_{th}	$V_{DS} = 3 \text{ V}, I_D = 1 \text{ mA}$	0.35	—	1.0	V
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 3 \text{ V}, I_D = 100 \text{ mA}$ (Note 2)	0.14	0.28	—	S
Drain-source ON-resistance	$R_{DS(ON)}$	$I_D = 100 \text{ mA}, V_{GS} = 4.5 \text{ V}$ (Note 2)	—	1.65	2.20	Ω
		$I_D = 50 \text{ mA}, V_{GS} = 2.5 \text{ V}$ (Note 2)	—	2.16	3.02	
		$I_D = 20 \text{ mA}, V_{GS} = 1.8 \text{ V}$ (Note 2)	—	2.66	4.05	
		$I_D = 10 \text{ mA}, V_{GS} = 1.5 \text{ V}$ (Note 2)	—	3.07	5.60	
Input capacitance	C_{iss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	—	12	—	pF
Output capacitance	C_{oss}		—	5.5	—	
Reverse transfer capacitance	C_{rss}		—	4.1	—	
Switching time	Turn-on time	t_{on}	$V_{DD} = 10 \text{ V}, I_D = 100 \text{ mA}$		—	ns
	Turn-off time	t_{off}	$V_{GS} = 0 \text{ to } 2.5 \text{ V}, R_G = 50 \Omega$		—	
Drain-source forward voltage	V_{DSF}	$I_D = -250 \text{ mA}, V_{GS} = 0 \text{ V}$ (Note 2)	—	-0.9	-1.2	V

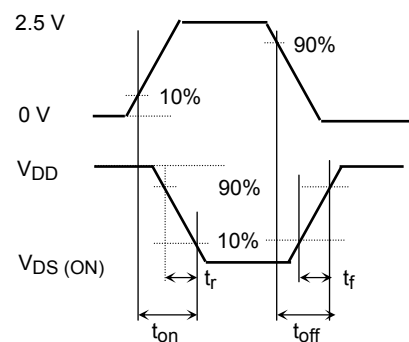
Note2: Pulse test

Switching Time Test Circuit

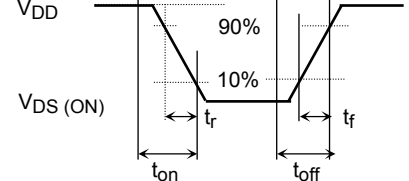
(a) Test Circuit



(b) V_{IN}



(c) V_{OUT}



Precaution

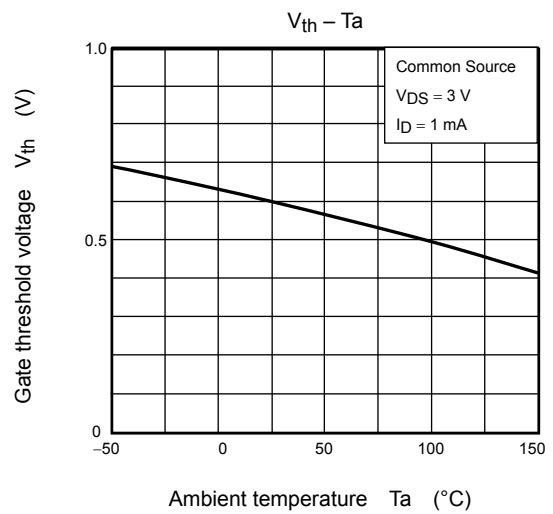
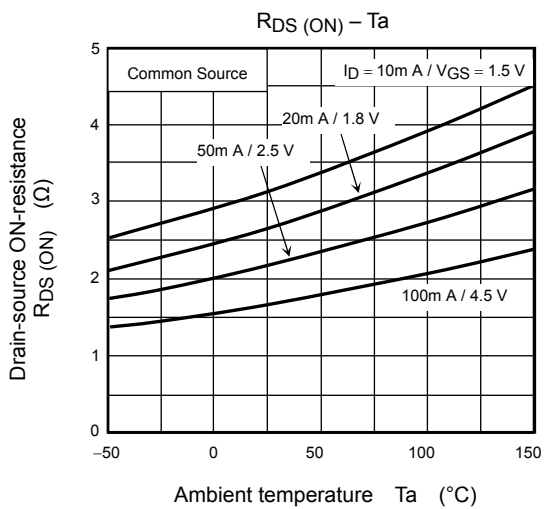
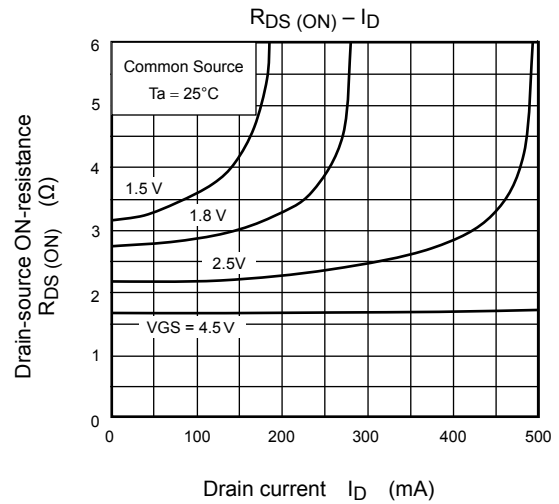
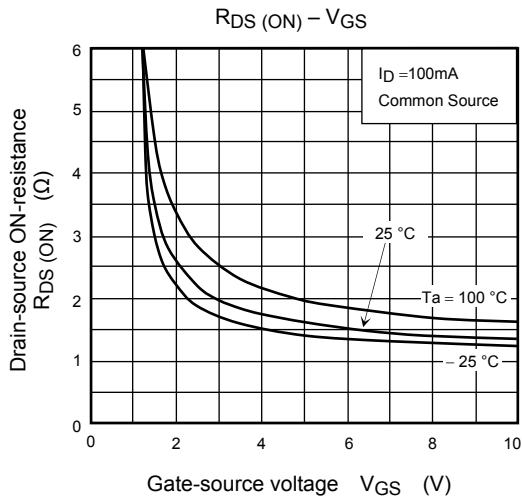
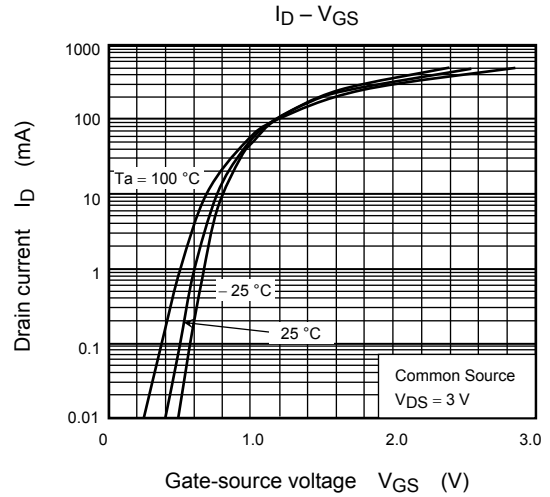
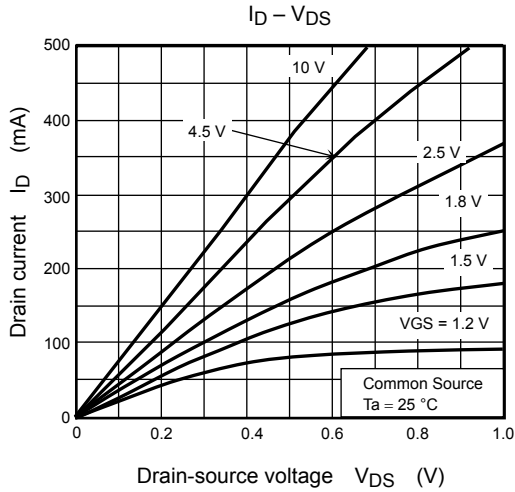
V_{th} can be expressed as the voltage between gate and source when the low operating current value is $I_D = 1 \text{ mA}$ for this product. For normal switching operation, $V_{GS(ON)}$ requires a higher voltage than V_{th} and $V_{GS(OFF)}$ requires a lower voltage than V_{th} . (The relationship can be established as follows: $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$.)

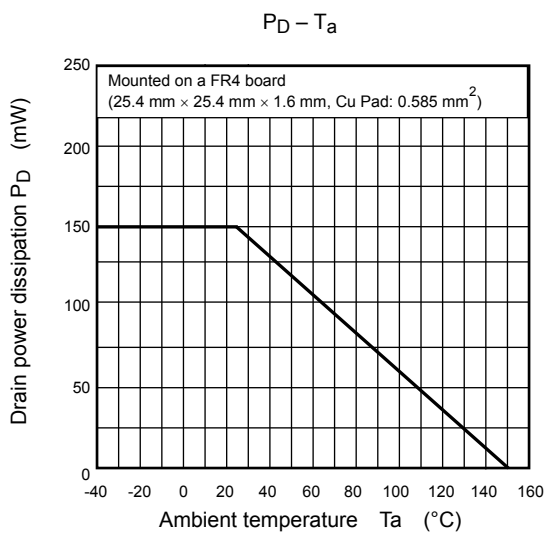
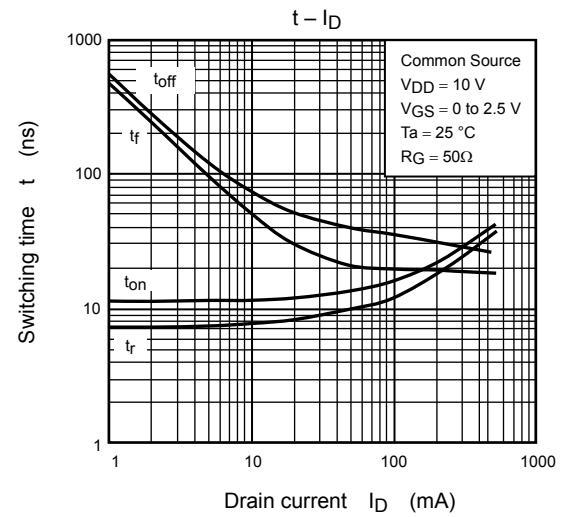
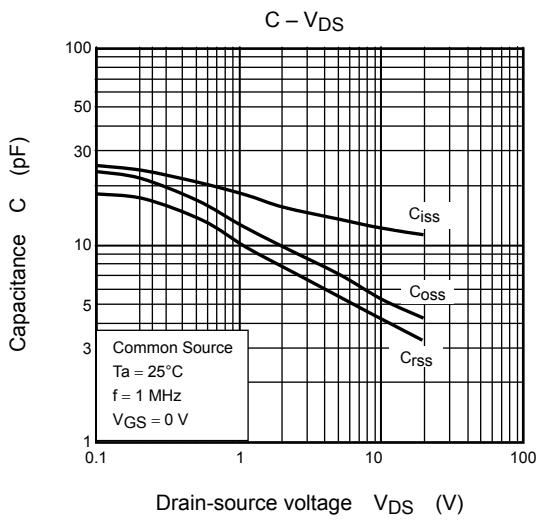
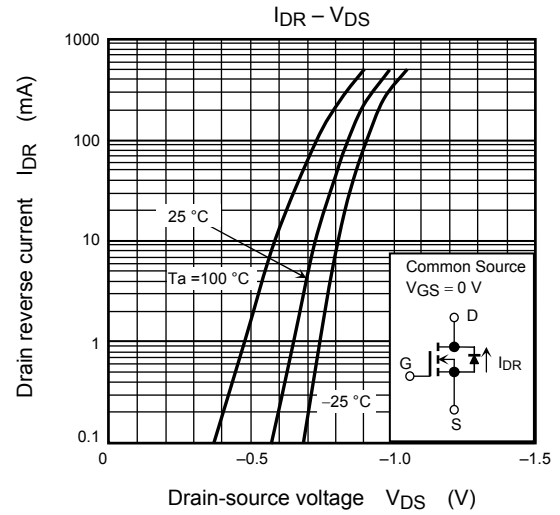
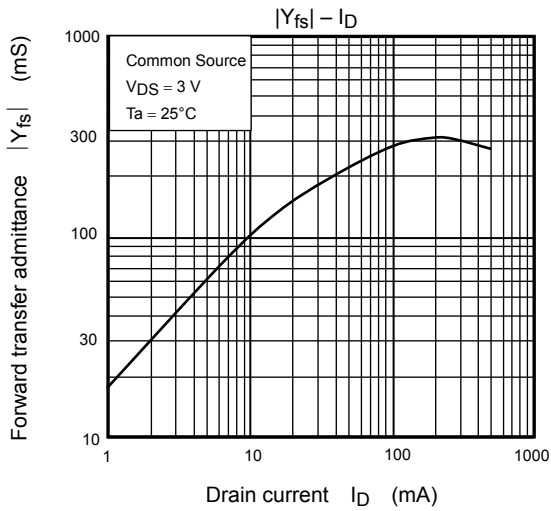
Take this into consideration when using the device.

Do not use this device under avalanche mode. It may cause the device to break down.

Handling Precaution

When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.





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